

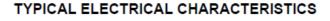
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
Static						
BV_{DSS}	Drain-Source Breakdown Voltage $V_{GS}=0V, I_D=250\mu A$		60			V
$V_{\text{GS(th)}}$	Gate Threshold Voltage V _{DS} =V _{GS} , I _D =250uA		1		2.5	V
I _{GSS}	Gate-Body Leakage	Body Leakage V _{DS} =0V,V _{GS} =±20V			±10	uA
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$			1	μA
$R_{\text{DS(ON)}}$	Drain-Source On-Resistance	V_{GS} =10V, I_{D} =0.5A			2.3	Ω
		V_{GS} =5V, I_{D} =0.05A			2.7	Ω
V_{SD}	Diode Forward Voltage (Note 2)	$I_{s} = 115 \text{mA}, V_{gs} = 0 \text{V}$			1.4	V
g _{FS}	Forward Transconductance	80			mS	
Dynamic						
C _{iss}	Input Capacitance			25		pF
C _{oss}	Output Capacitance	V_{DS} =25V, V_{GS} =0V, f=1MHz		5.5		
C _{rss}	Reverse Transfer Capacitance			3		
Qg	Total Gate Charge			0.71		nC
Q_{GS}	Gate-to-Source Charge	$V_{DS} = 10V, V_{GS} = 4.5V,$ $I_{D} = 0.5A$		0.6		
Q_{GD}	Gate-to-Drain Charge	$I_D = 0.5A$		0.16		
$t_{d(on)}$	Turn-On Delay Time (Note 3)			1.5		
t,	Turn-On Rise Time	$V_{DS} = 10V, I_{D} = 0.5A,$		22		ns
$t_{d(off)}$	Turn-Off Delay Time	V_{EN} = 10V, R_{G} =25 Ω		3		
t _f	Turn-On Fall Time			22		

Electrical Characteristics (TA = 25 $^{\circ}$ C Unless Otherwise Specified)

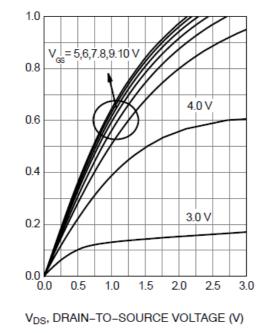
Note : 2. Pulse Test: pulse width \leq 300 us, duty cycle \leq 2%

3. Switching characteristics are independent of operating junction temperatures

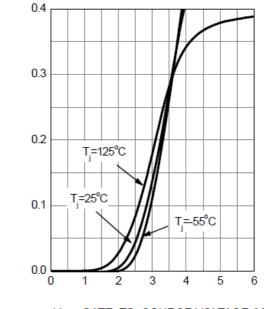




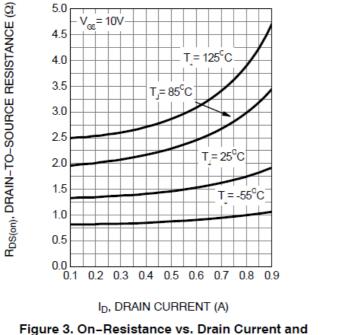
ID, DRAIN CURRENT (A)



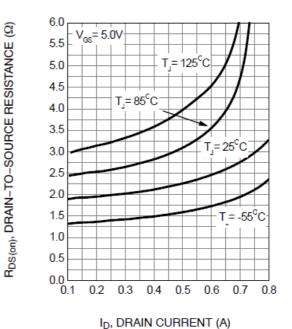


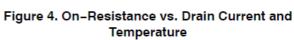


V_{GS}, GATE-TO-SOURCE VOLTAGE (V) Figure 2. Transfer Characteristics



Temperature







TYPICAL ELECTRICAL CHARACTERISTICS

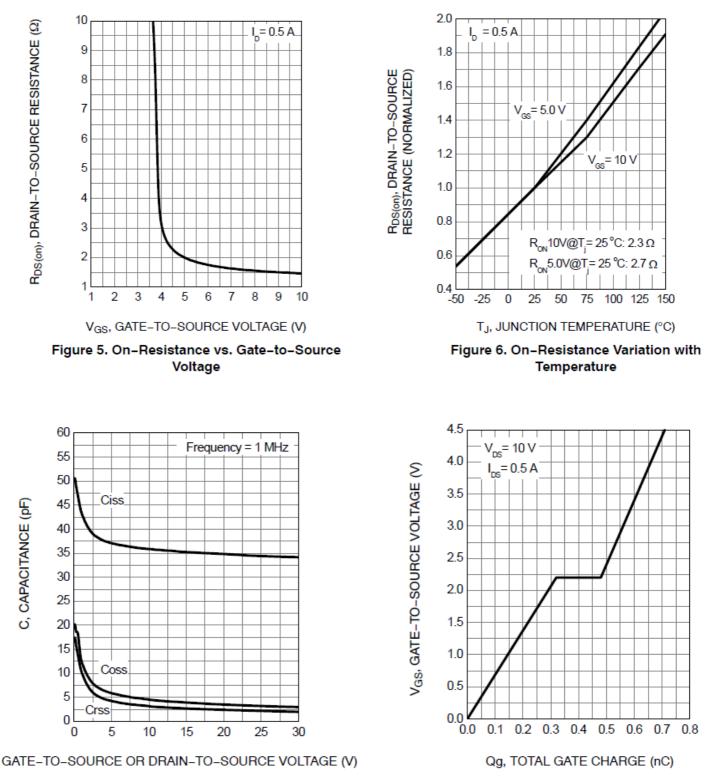


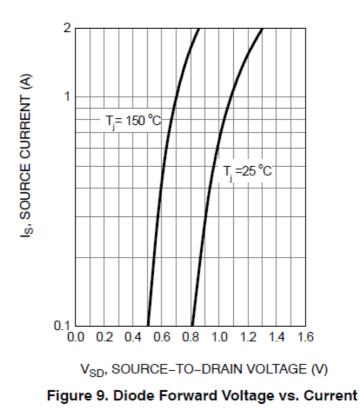
Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge



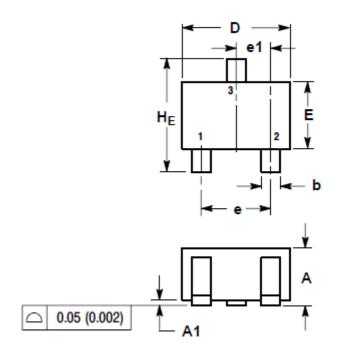
TYPICAL ELECTRICAL CHARACTERISTICS

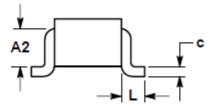
<u>2N7002KW</u>





Package Dimension : SOT-323





<u>2N7002KW</u>

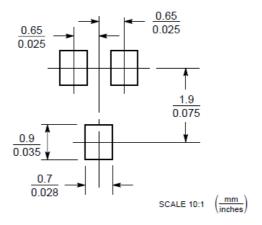
NOTES:

 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.90	1.00	0.032	0.035	0.040	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A2	0.7 REF			0.028 REF			
b	0.30	0.35	0.40	0.012	0.014	0.016	
С	0.10	0.18	0.25	0.004	0.007	0.010	
D	1.80	2.10	2.20	0.071	0.083	0.087	
E	1.15	1.24	1.35	0.045	0.049	0.053	
e	1.20	1.30	1.40	0.047	0.051	0.055	
e1	0.65 BSC			0.026 BSC			
L	0.425 REF			0.017 REF			
HE	2.00	2.10	2.40	0.079	0.083	0.095	

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